7250 Hudson Blvd., Suite 100, Oakdale, MN 55128
Tel.: 1 651-730-1188, Fax: 1 651-730-1282

Test Verification of Conformity

On the basis of the tests undertaken, the sample(s) of the below product have been found to comply with the essential requirements of the referenced specifications at the time the tests were carried out.

Applicant Name & Address	:	**Remote Technologies** **5775 12th Ave East** **Suite 180** **Shakopee, MN 55379, USA**
Product(s) Tested	:	**Remote Control**
Model(s)	:	**T1-B+**
Brand name	:	**RTI**
Relevant Standard(s)/Specification(s)	:	**EN 55022:2010 / AC:2011, Class B** **AS/NZS CISPR 22:2009, Amdt 1:2010** **47 CFR, Part 15:2010, §15.107 and §15.109, Class B** **ICES-003, Issue 5:2012** **EN 55024:2010** **AS/NZS CISPR 24: 2002, Amdt 1:2009, Amdt 2:2009**
Verification Issuing Office Name & Address	:	**Intertek, Oakdale, Minnesota** **EMC Department**
Date of Test(s)	:	**April 12 - 16, 2013**
Verification/Report Number(s)	:	**101141549MIN-001**

NOTE : This verification is part of the full test report(s) and should be read in conjunction with it.

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Signature: _____

Name:	**Norman Shpilsher**
Position:	**EMC Engineering Team Leader**
Date:	**April 19, 2013**